



SSC8329GS1

Dual P-Channel Enhancement Mode MOSFET

➤ Features

V_{DS}	V_{GS}	$R_{DS(ON)}$ Typ.	I_D
-20V	$\pm 12V$	13m Ω @-4V5	-13A
		16m Ω @-2V5	

➤ Description

This device is produced with high cell density, DMOS trench technology, which is especially used to minimize on-state resistance. This device is particularly suited for low voltage power management requiring a wide range of given voltage ratings(4.5V~25V) such as load switch and battery protection.

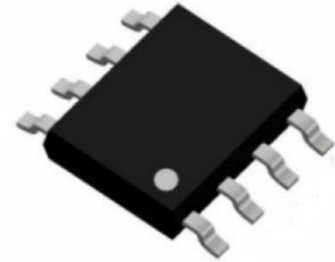
➤ Applications

- NB Battery
- DC/DC Conversion
- Load Switch

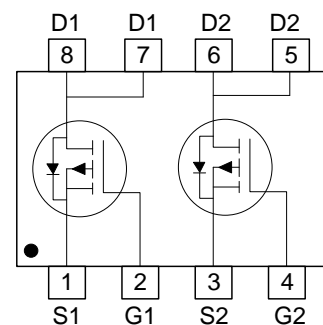
➤ Ordering Information

Device	Package	Shipping
SSC8329GS1	SOP-8	4000/Reel

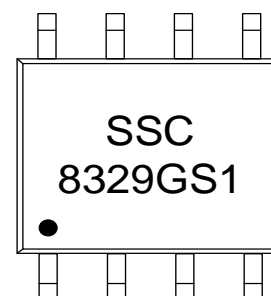
➤ Pin configuration



SOP-8 (Top View)



Pin Configuration



Marking



➤ **Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain-to-Source Voltage	-20	V
V_{GSS}	Gate-to-Source Voltage	± 12	V
I_D	Continuous Drain Current ^a	-13	A
I_{DM}	Pulsed Drain Current ^b	-51	A
P_D	Power Dissipation ^c	5.4	W
P_{DSM}	Power Dissipation ^a	2.2	W
T_J	Operation junction temperature	-55~150	°C
T_{STG}	Storage temperature range	-55~150	

➤ **Thermal Resistance Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)**

Symbol	Parameter	Maximum	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a	60	°C/W
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	25	

Note:

- The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user is specific board design. The power dissipation is based on the $t \leq 10\text{s}$ thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_D is based on $T_{J(MAX)}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

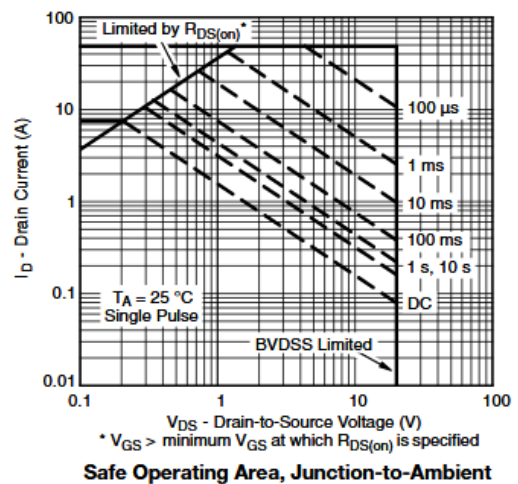
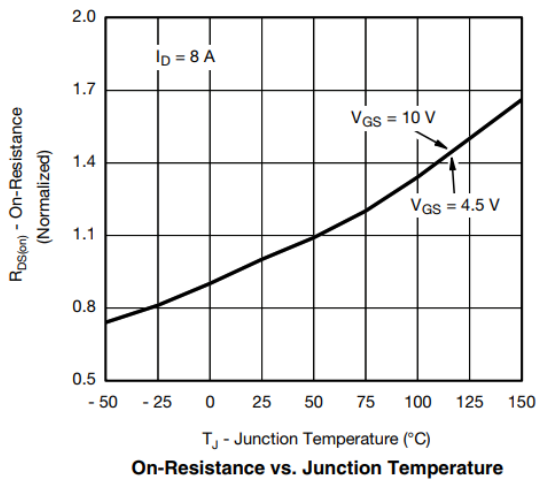
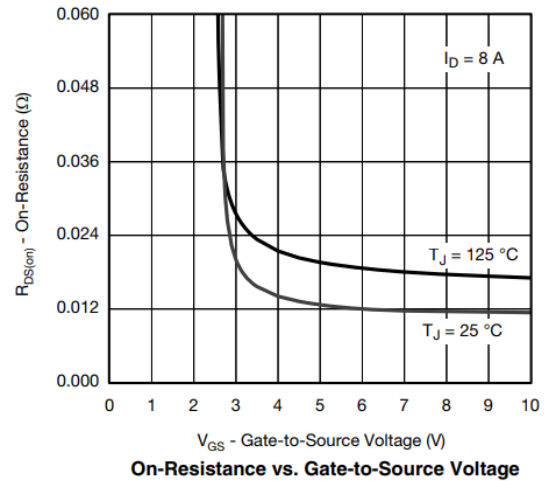
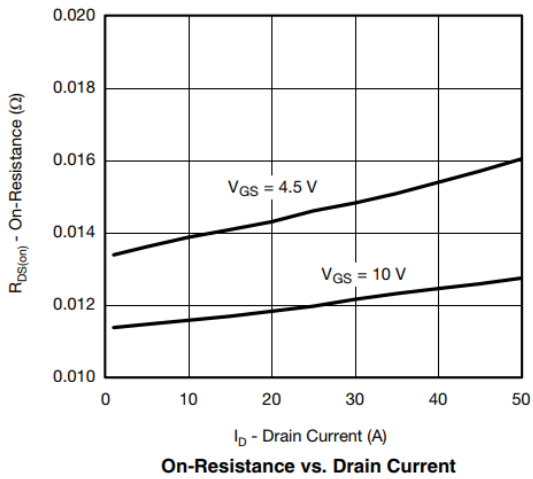
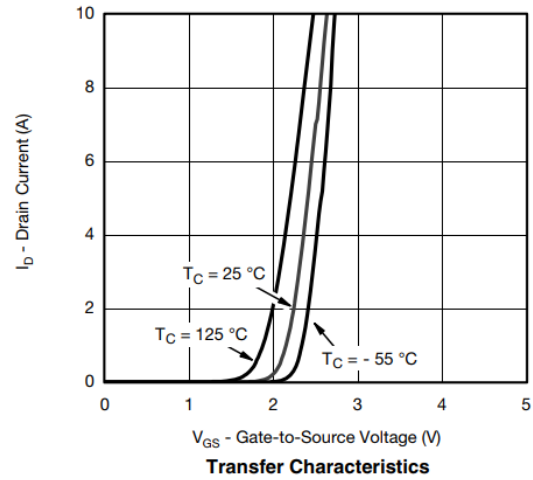
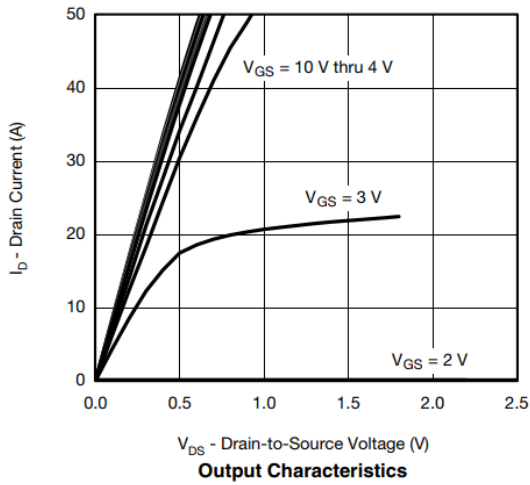


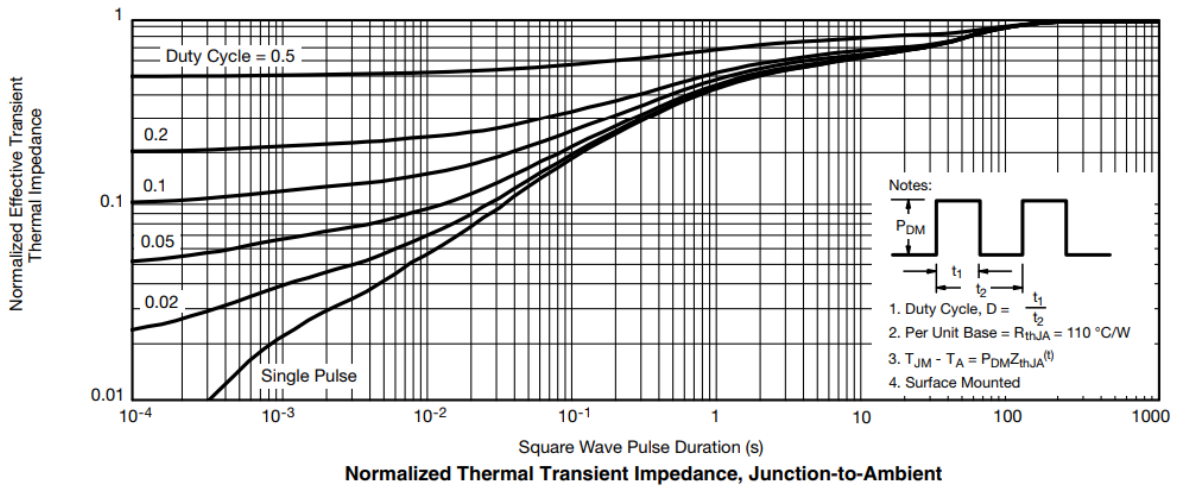
➤ **Electrical Characteristics (T_A=25°C unless otherwise noted)**

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.5		-1.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -10A		13	18	mΩ
		V _{GS} = -2.5V, I _D = -7A		16	22	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16V, V _{GS} = 0V			-1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±12V, V _{DS} = 0V			±100	nA
Transconductance	G _{FS}	V _{DS} = -10V, I _D = -3.6A		16		s
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = -2.3A			-1.3	V
Input Capacitance	C _{ISS}	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		1020		pF
Output Capacitance	C _{OSS}			110		
Reverse Transfer Capacitance	C _{RSS}			90		
Total Gate Charge	Q _G	V _{GS} = -4.5V, V _{DS} = -15V, I _D = -3A		13		nC
Gate to Source Charge	Q _{GS}			3.3		
Gate to Drain Charge	Q _{GD}			4.4		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = -10V, V _{DS} = -15V, R _L = 1.5Ω, R _G = 3Ω		11		ns
Rise Time	T _r			10		
Turn-off Delay Time	T _{D(OFF)}			51		
Fall Time	T _f			29		

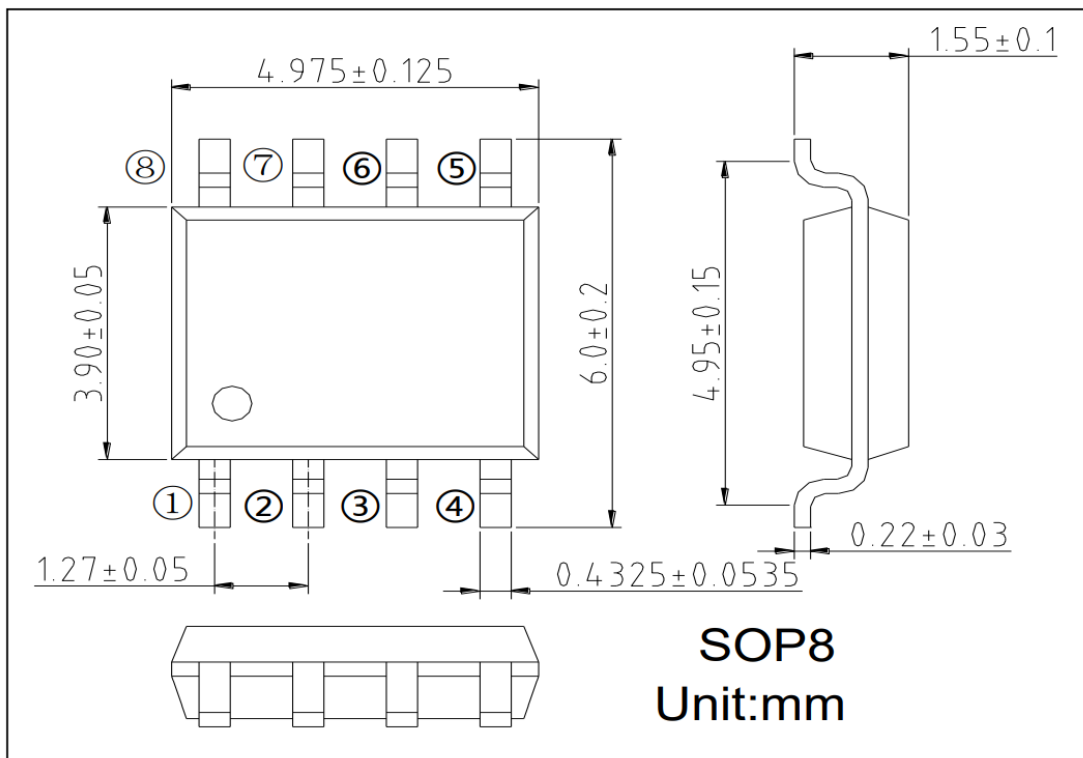


➤ Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)





➤ Package Information





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